

C0603C302F5GACTU

Aliases (C0603C302F5GAC7867) SMD Comm COG, Ceramic, 3,000 pF, 1%, 50 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0603, 0.5 mm



General Information		
Series	SMD Comm COG	
Style	SMD Chip	
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I	
Features	Ultra-Stable, Low Loss, Class I	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	3.7 mg	
Shelf Life	78 Weeks	
MSL	1	

Dimensions	
Chip Size	0603
L	1.6mm +/-0.15mm
W	0.8mm +/-0.15mm
Т	0.8mm +/-0.07mm
S	0.5mm MIN
В	0.35mm +/-0.15mm

4000

Packaging Quantity

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Т	0.8mm +/-0.07mm	Voltage DC
S	0.5mm MIN	Dielectric Withstanding
В	0.35mm +/-0.15mm	Temperature Range
		Temp. Coefficient
Packaging Specifications		Capacitance Change v
Packaging	T&R, 180mm, Paper Tape	Reference to +25°C an Applied (TCC)

Specifications	
Capacitance	3,000 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	1%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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